



# 1A Low Dropout Positive Voltage Regulator LM1117M3 series

## Features

- Adjustable or Fixed Output
- Output Current of 1A
- Low Dropout, 1.4V max at 1A Output Current
- Good Noise Rejection
- Output Current Limiting
- Built-in Thermal Shutdown
- Fast Transient Response
- Can operate using MLCCs in the capacitance range of 2μF to 10μF

## Description

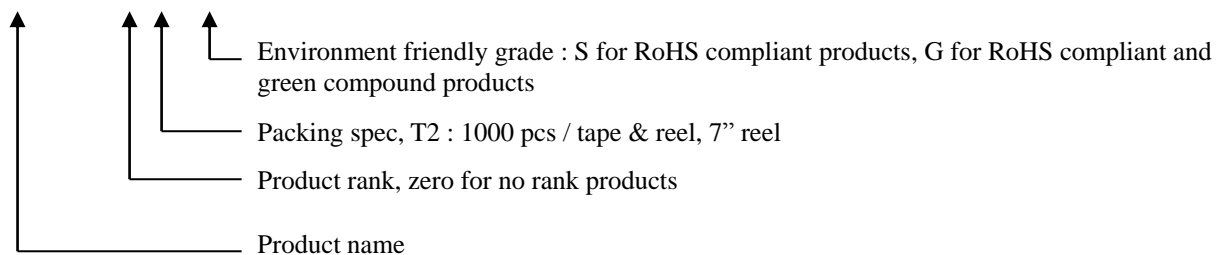
The LM1117 series of positive adjustable and fixed regulators are designed to provide 1A with high efficiency. All internal circuitry is designed to operate down to 1.4V input to output differential. The product is specifically designed to provide well-regulated supply for low-voltage IC application such as high-speed bus termination and low current 3.3V logic supply, and other applications such as VGA cards.

## Applications

- High Efficiency Linear Regulators
- Post Regulators for Switching Supplies
- Adjustable Power Supply

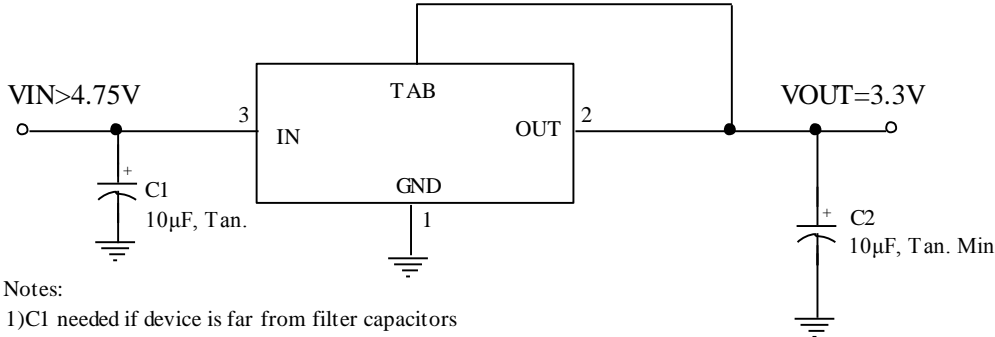
## Ordering Information

Device	Output Voltage	Package	Shipping
LM1117-ADJM3-0-T2-G	Adjustable	SOT-89 (Pb-free lead plating and halogen-free package)	1000 pcs / Tape & Reel
LM1117-1.5M3 -0-T2-G	1.5V		
LM1117-1.8M3 -0-T2-G	1.8V		
LM1117-2.5M3 -0-T2-G	2.5V		
LM1117-3.3M3 -0-T2-G	3.3V		
LM1117-5.0M3 -0-T2-G	5.0V		



## Typical Application Data

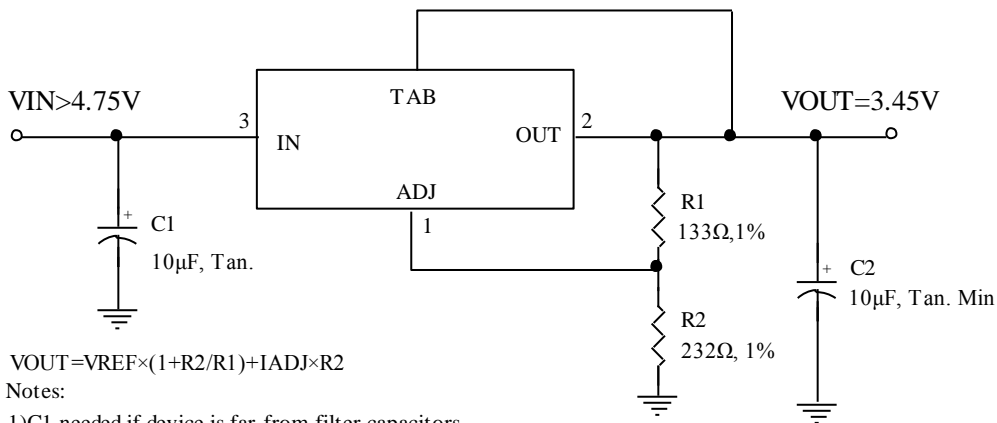
### Fixed Voltage Regulator



Notes:

- 1) C1 needed if device is far from filter capacitors
- 2) C2 minimum value required for stability

### Adjustable Voltage Regulator

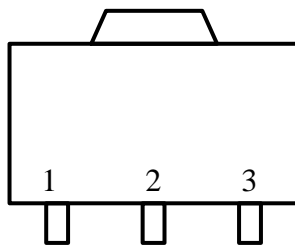


$$V_{OUT} = V_{REF} \times (1 + R2/R1) + I_{ADJ} \times R2$$

Notes:

- 1) C1 needed if device is far from filter capacitors
- 2) C2 minimum value required for stability

## Package Information



SOT-89

Pin	Name
1	ADJ/GND
2	OUTPUT
3	INPUT

## Absolute Maximum Ratings (TA=25°C)

Symbol	Parameter	Maximum	Units
P <sub>D</sub>	Power Dissipation	330	mW
V <sub>IN</sub>	Input Voltage	20	V
T <sub>OPR</sub>	Operating Junction Temperature Range	-40 ~ +125	°C
T <sub>STG</sub>	Storage Temperature	-65 ~ +150	°C
T <sub>MJ</sub>	Maximum Junction Temperature	150	°C

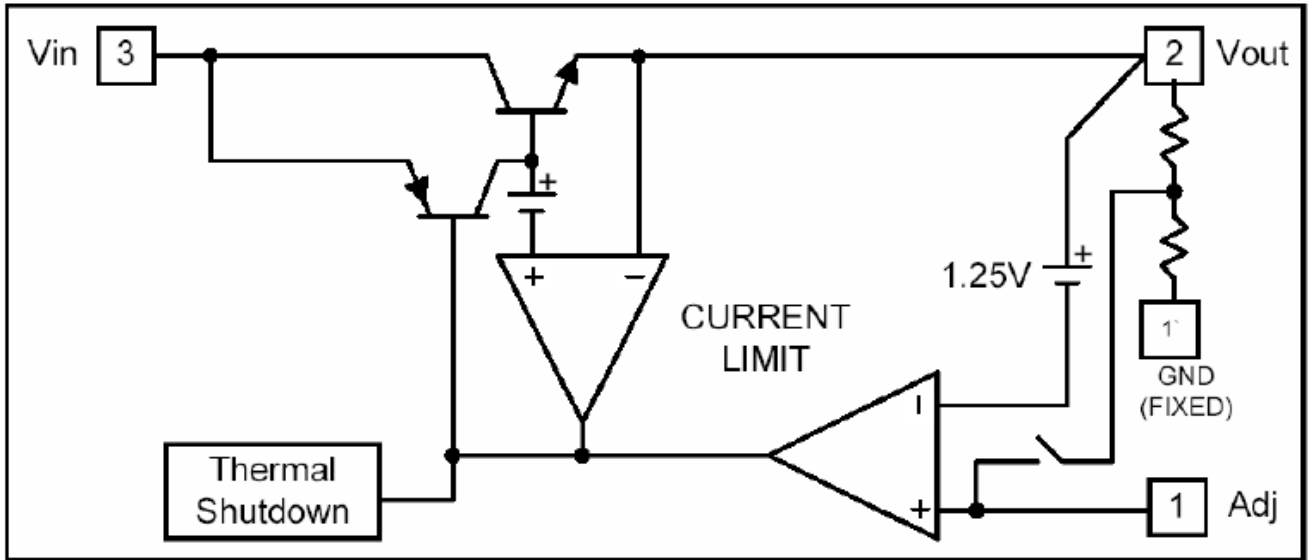


**Electrical Characteristics @  $I_o=10mA, T_J=25^\circ C$ , unless otherwise specified**

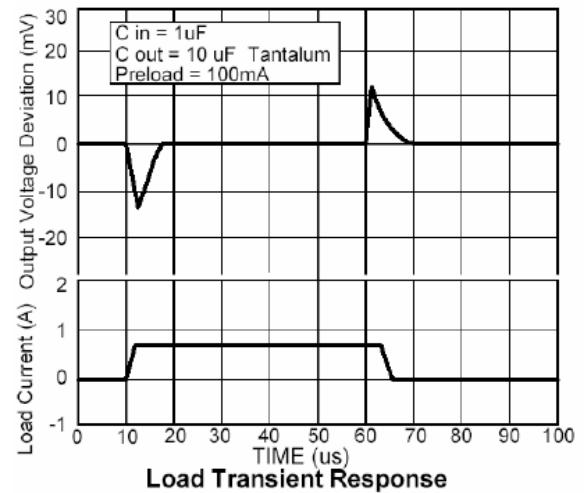
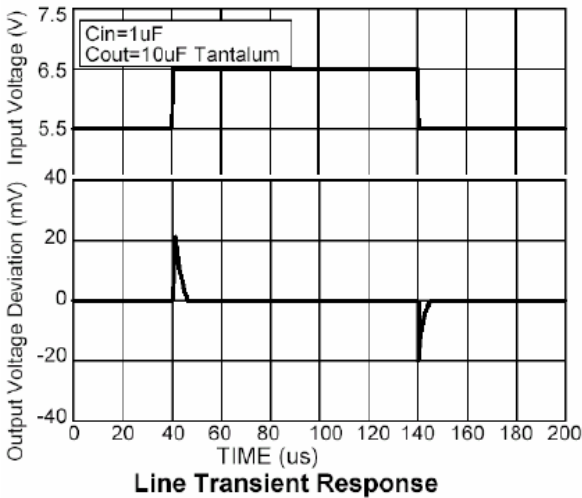
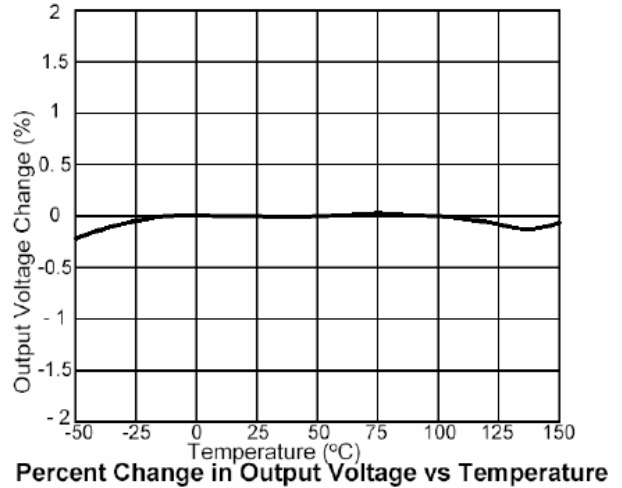
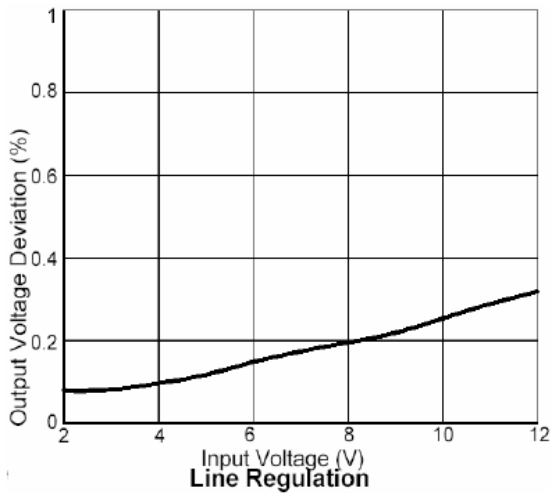
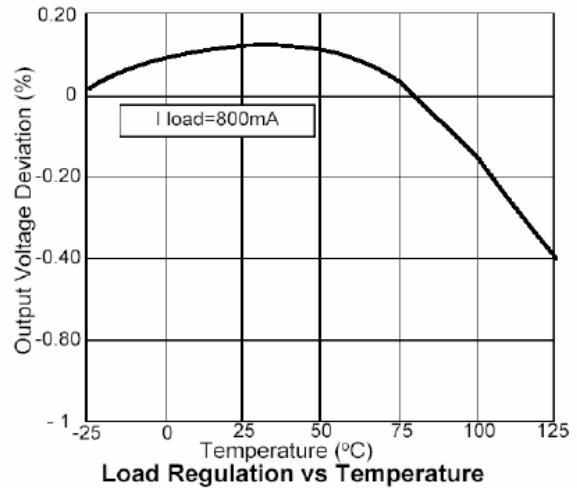
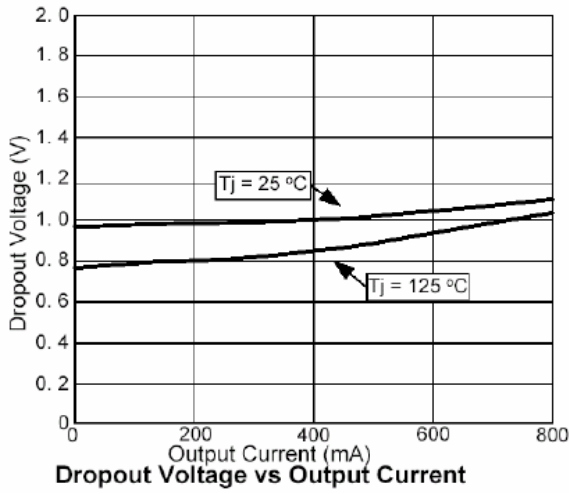
Parameter	Device	Test Conditions	Min	Typ	Max	Units
Reference voltage	Adj version	$V_{IN}-V_{OUT}=1.5V$	1.225	1.250	1.275	V
Output Voltage	LM1117-1.5	$3.0V \leq V_{IN} \leq 12V$	1.470	1.500	1.530	V
	LM1117-1.8	$3.3V \leq V_{IN} \leq 12V$	1.764	1.800	1.836	V
	LM1117-2.5	$4.0V \leq V_{IN} \leq 12V$	2.450	2.500	2.550	V
	LM1117-3.3	$4.8V \leq V_{IN} \leq 12V$	3.235	3.300	3.365	V
	LM1117-5.0	$6.5V \leq V_{IN} \leq 12V$	4.900	5.000	5.100	V
Line Regulation	All version	$V_{OUT}+1.5V \leq V_{IN} \leq 12V$	-	-	0.2	%
Load Regulation (Note 1, 2)	LM1117-ADJ	$V_{IN}=3.3V, V_{adj}=0, 10mA \leq I_o \leq 1A$	-	-	1	%
	LM1117-1.5	$V_{IN}=3.0V, 0mA \leq I_o \leq 1A$	-	12	15	mV
	LM1117-1.8	$V_{IN}=3.3V, 0mA \leq I_o \leq 1A$	-	15	18	mV
	LM1117-2.5	$V_{IN}=4.0V, 0mA \leq I_o \leq 1A$	-	20	25	mV
	LM1117-3.3	$V_{IN}=5.0V, 0mA \leq I_o \leq 1A$	-	26	33	mV
	LM1117-5.0	$V_{IN}=8.0V, 0mA \leq I_o \leq 1A$	-	40	50	mV
Dropout Voltage ( $V_{IN}-V_{OUT}$ )	All version	$I_o=1A (\Delta V_{OUT}=1\% V_{OUT})$	-	1.3	1.4	V
Current Limit	All version	$V_{IN}-V_{OUT}=5V$	1.1	-	-	A
Minimum Load Current	Adj version	$V_{IN}=5V$	-	5	10	mA
Adjust Pin Current	Adj version	$V_{IN}=12V, I_o=10mA$	-	50	100	$\mu A$
Quiescent Current	Fixed version	$V_{IN}=12V, I_o=0mA$	-	-	12	mA
Thermal Regulation	All version	$T_A=25^\circ C, 30ms$ pulse	-	0.008	0.04	%/W
Ripple Rejection	All version	$f=120Hz, V_{IN}=V_{OUT}+3V, I_o=1A, C_{OUT}=25\mu F$ tantalum	60	70	-	dB
Temperature Stability	All version	$I_o=10mA$	-	0.5	-	%
Thermal Resistance, Junction to Ambient (No heat sink, no air flow)	All version		-	300	-	$^\circ C/W$
Thermal Resistance, Junction to Case	All version	Control Circuitry/ Power transistor	-	100	-	$^\circ C/W$

Note : 1. See thermal regulation specifications for changes in output voltage due to heating effects. Line and load regulation are measured at a constant junction temperature by low duty cycle pulse testing. Load regulation is measured at the output lead 1/18" from the package.  
 2. Line and load regulation are guaranteed up to the maximum power dissipation of 1W. Power dissipation is determined by the difference in input and output and the output current. Guaranteed maximum power dissipation will not be available over the full input/output range.

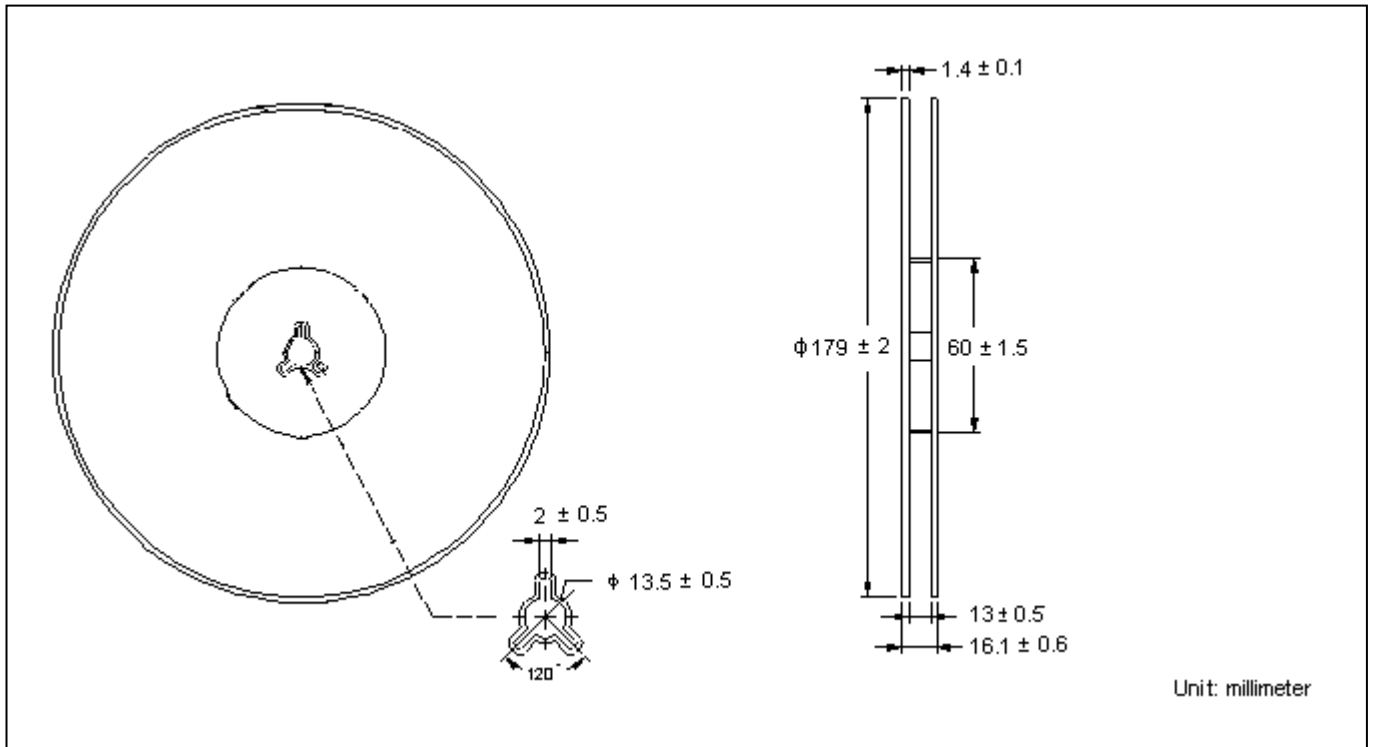
Block Diagram



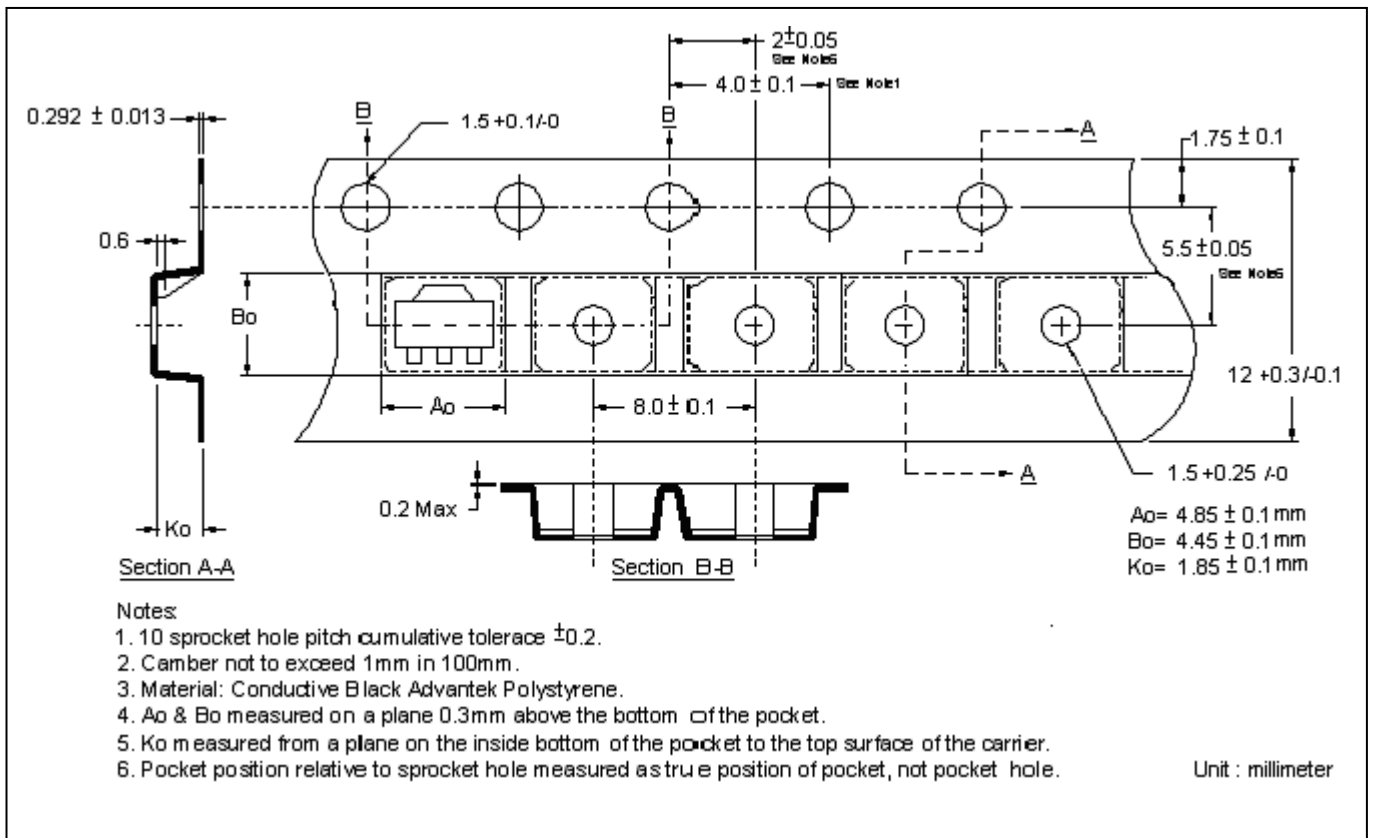
**Characteristic Curves**



### Reel Dimension



### Carrier Tape Dimension



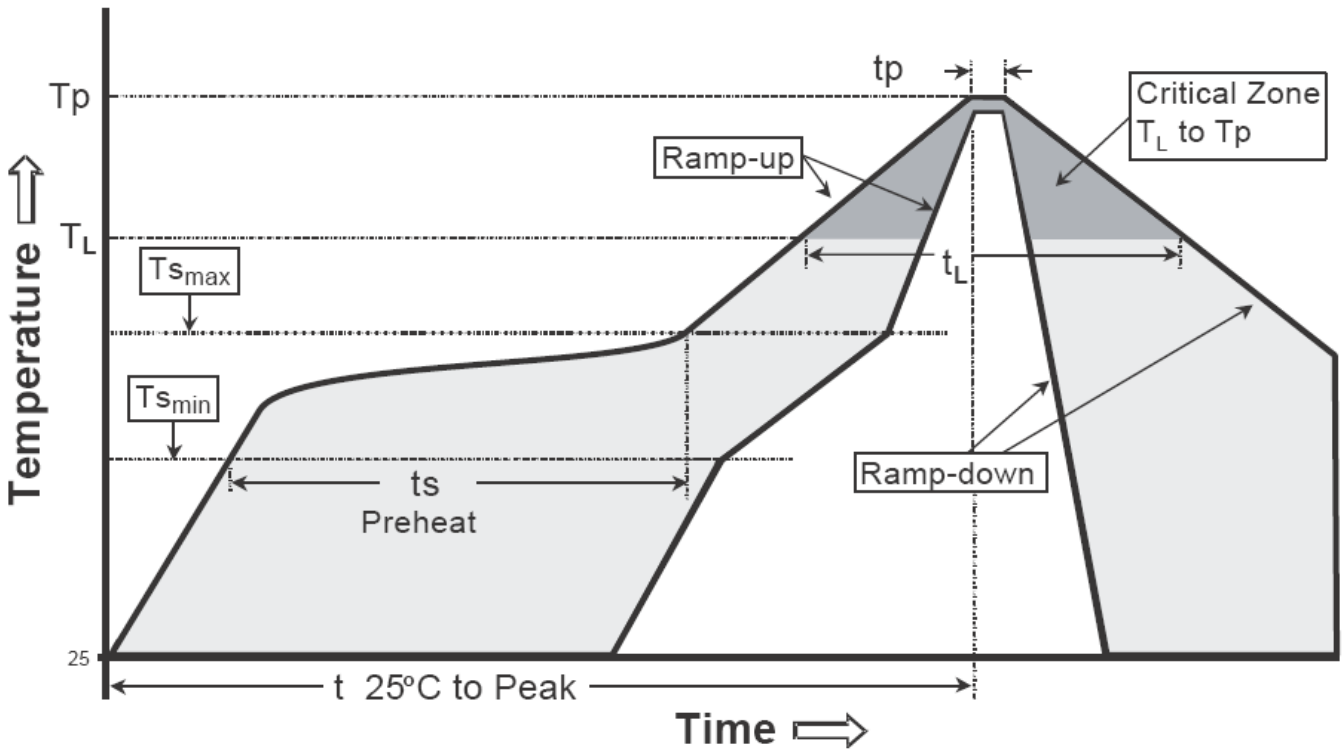
**Notes:**

1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ .
2. Camber not to exceed 1mm in 100mm.
3. Material: Conductive Black Advantek Polystyrene.
4.  $A_o$  &  $B_o$  measured on a plane 0.3mm above the bottom of the pocket.
5.  $K_o$  measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

**Recommended wave soldering condition**

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

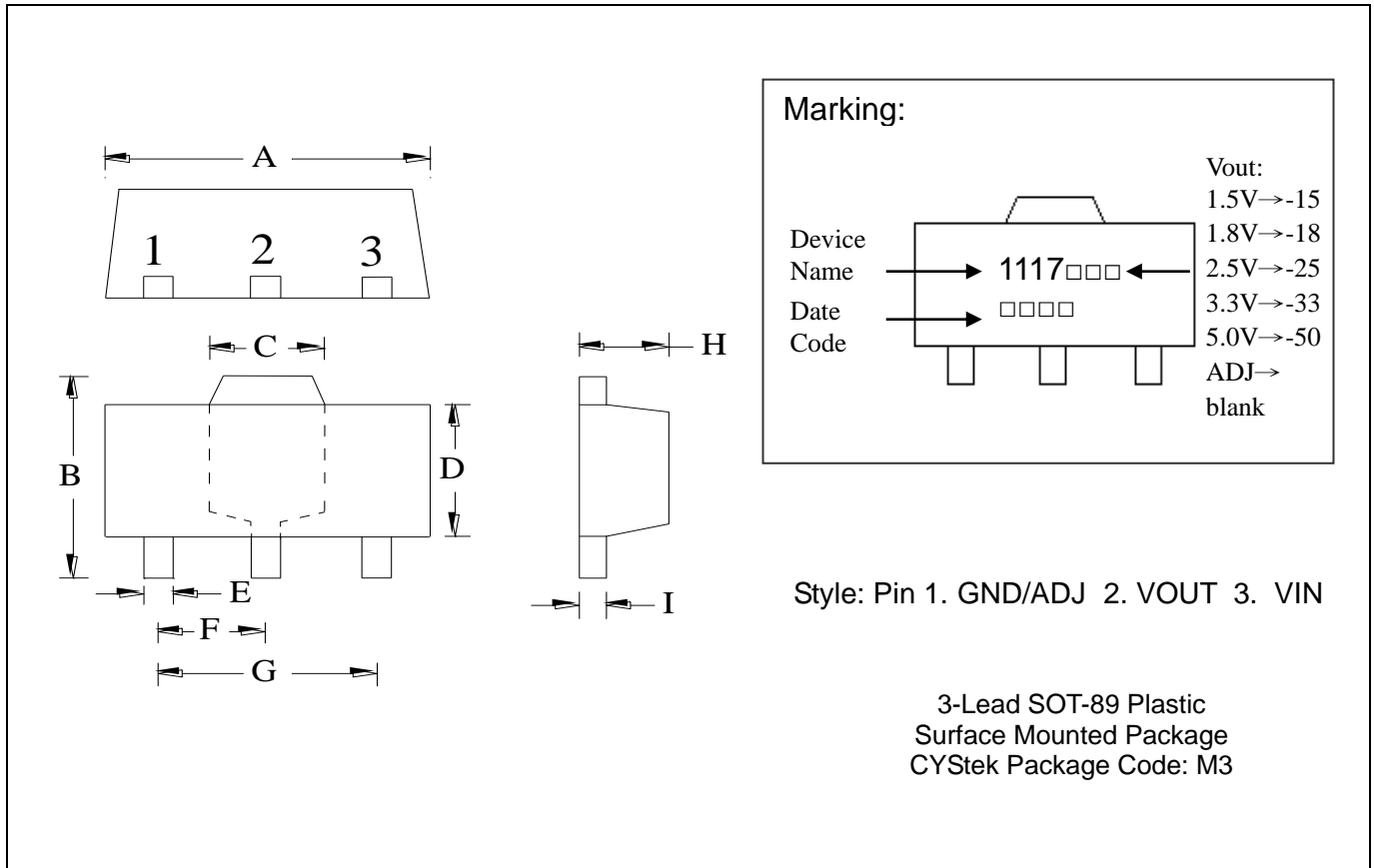
**Recommended temperature profile for IR reflow**



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat		
-Temperature Min(Ts min)	100°C	150°C
-Temperature Max(Ts max)	150°C	200°C
-Time(ts min to ts max)	60-120 seconds	60-180 seconds
Time maintained above:		
-Temperature (Tl)	183°C	217°C
- Time (tl)	60-150 seconds	60-150 seconds
Peak Temperature(Tp)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

**SOT-89 Dimension**



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1732	0.1811	4.40	4.60	F	0.0591	TYP	1.50	TYP
B	0.1551	0.1673	3.94	4.25	G	0.1181	TYP	3.00	TYP
C	0.0610	REF	1.55	REF	H	0.0551	0.0630	1.40	1.60
D	0.0906	0.1024	2.30	2.60	I	0.0138	0.0173	0.35	0.44
E	0.0126	0.0205	0.32	0.52					

**Notes:** 1.Controlling dimension: millimeters.  
 2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.  
 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

**Material:**

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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